

Bonding and sealing

TESCON PRIMER RP

Solvent-free primer, no drying required

Field of application

Adhesive primer for wood, wood fiberboards, masonry, rendering and concrete.
For preparing or improving the surface before the application of TESCON VANA adhesive tape and ORCON F joint adhesive.

Advantages

No drying required – bonding is possible directly in the wet primer on absorbent substrates; deep penetration; strengthens the substrate; solvent-free; suitable for application with all pro clima adhesive tapes.



developed and produced by pro clima

Material	Acrylate copolymer, solvent free
Temperature resistance	- 40°C to + 90°C
Processing temperature	- 10°C to + 45°C
Storage	Store in a frost-free place

Item no.	Bottle	Contents per box	Coverage (with adhesive tape width of 60 mm)	
6103TESCONPRIMER	1.0 ltr	6 bottles	ca. 75 m	